



**AO4420**

**N-Channel Enhancement Mode Field Effect Transistor**

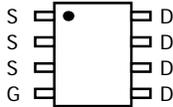


**General Description**

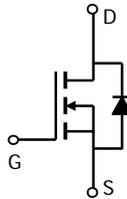
The AO4420 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , shoot-through immunity and body diode characteristics. This device is suitable for use as a synchronous switch in PWM applications. *Standard Product AO4420 is Pb-free (meets ROHS & Sony 259 specifications). AO4420L is a Green Product ordering option. AO4420 and AO4420L are electrically identical.*

**Features**

- $V_{DS}$  (V) = 30V
- $I_D$  = 13.7A ( $V_{GS}$  = 10V)
- $R_{DS(ON)}$  < 10.5m $\Omega$  ( $V_{GS}$  = 10V)
- $R_{DS(ON)}$  < 12m $\Omega$  ( $V_{GS}$  = 4.5V)



**SOIC-8**



**Absolute Maximum Ratings  $T_A=25^\circ\text{C}$  unless otherwise noted**

| Parameter                              | Symbol         | Maximum                | Units            |
|--|----------------|------------------------|------------------|
| Drain-Source Voltage                   | $V_{DS}$       | 30                     | V                |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 12$               | V                |
| Continuous Drain Current <sup>A</sup>  | $I_D$          | $T_A=25^\circ\text{C}$ | A                |
|  |                | $T_A=70^\circ\text{C}$ |                  |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | 60                     |                  |
| Power Dissipation                      | $P_D$          | $T_A=25^\circ\text{C}$ | W                |
|  |                | $T_A=70^\circ\text{C}$ |                  |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150             | $^\circ\text{C}$ |

**Thermal Characteristics**

| Parameter                                | Symbol          | Typ                 | Max | Units              |                    |
|--|-----------------|---------------------|-----|--------------------|--------------------|
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JA}$ | $t \leq 10\text{s}$ | 28  | 40                 | $^\circ\text{C/W}$ |
|  |                 | Steady-State        | 54  | 75                 | $^\circ\text{C/W}$ |
| Maximum Junction-to-Lead <sup>C</sup>    | $R_{\theta JL}$ | 21                  | 30  | $^\circ\text{C/W}$ |                    |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions   | Min                                       | Typ   | Max  | Units         |
|-----------------------------|---------------------------------------|--|---|-------|------|---------------|
| <b>STATIC PARAMETERS</b>    |                                       |  |   |       |      |               |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$  | 30  |       |      | V             |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=24\text{V}$ , $V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                 |   | 0.004 | 1    | $\mu\text{A}$ |
|                             |                                       |  |   |       | 5    |               |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}$ , $V_{GS}=\pm 12\text{V}$                                       |   |       | 100  | nA            |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$   | 0.6                                       | 1.1   | 2    | V             |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS}=4.5\text{V}$ , $V_{DS}=5\text{V}$  | 40  |       |      | A             |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS}=10\text{V}$ , $I_D=13.7\text{A}$<br>$T_J=125^\circ\text{C}$                |   | 8.3   | 10.5 | m $\Omega$    |
|                             |                                       |  |   | 12.5  | 15   |               |
|                             |                                       |  | $V_{GS}=4.5\text{V}$ , $I_D=12.7\text{A}$ |       | 9.7  | 12            |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=5\text{V}$ , $I_D=13.7\text{A}$  | 30  | 37    |      | S             |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=1\text{A}$ , $V_{GS}=0\text{V}$   |   | 0.76  | 1    | V             |
| $I_S$                       | Maximum Body-Diode Continuous Current |  |   |       | 5    | A             |
| <b>DYNAMIC PARAMETERS</b>   |                                       |  |   |       |      |               |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}$ , $V_{DS}=15\text{V}$ , $f=1\text{MHz}$                         |   | 3656  | 4050 | pF            |
| $C_{oss}$                   | Output Capacitance                    |  |   | 256   |      | pF            |
| $C_{rss}$                   | Reverse Transfer Capacitance          |  |   | 168   |      | pF            |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$                          |   | 0.86  | 1.1  | $\Omega$      |
| <b>SWITCHING PARAMETERS</b> |                                       |  |   |       |      |               |
| $Q_g(4.5\text{V})$          | Total Gate Charge                     | $V_{GS}=4.5\text{V}$ , $V_{DS}=15\text{V}$ , $I_D=13.7\text{A}$                    |   | 30.5  | 36   | nC            |
| $Q_{gs}$                    | Gate Source Charge                    |  |   | 4.6   |      | nC            |
| $Q_{gd}$                    | Gate Drain Charge                     |  |   | 8.6   |      | nC            |
| $t_{D(on)}$                 | Turn-On Delay Time                    | $V_{GS}=10\text{V}$ , $V_{DS}=15\text{V}$ , $R_L=1.1\Omega$ ,<br>$R_{GEN}=3\Omega$ |   | 5.5   | 9    | ns            |
| $t_r$                       | Turn-On Rise Time                     |  |   | 3.4   | 7    | ns            |
| $t_{D(off)}$                | Turn-Off Delay Time                   |  |   | 49.8  | 75   | ns            |
| $t_f$                       | Turn-Off Fall Time                    |  |   | 5.9   | 11   | ns            |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=13.7\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                               |   | 22.5  | 28   | ns            |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=13.7\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$                               |   | 12.5  | 16   | nC            |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using 80  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

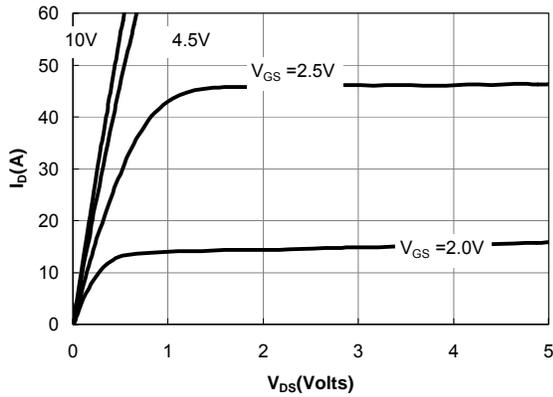


Figure 1: On-Regions Characteristics

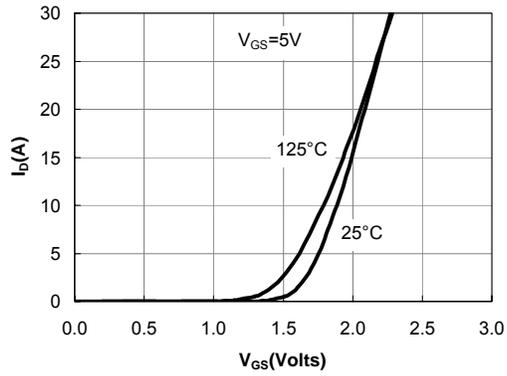


Figure 2: Transfer Characteristics

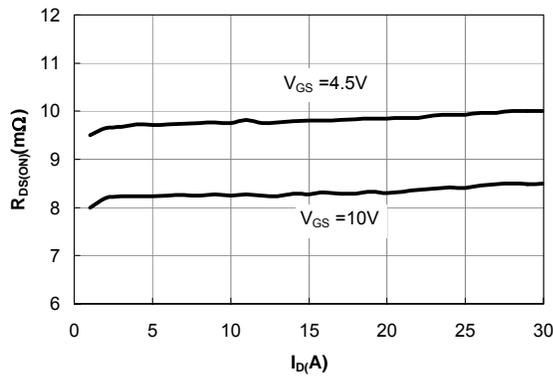


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

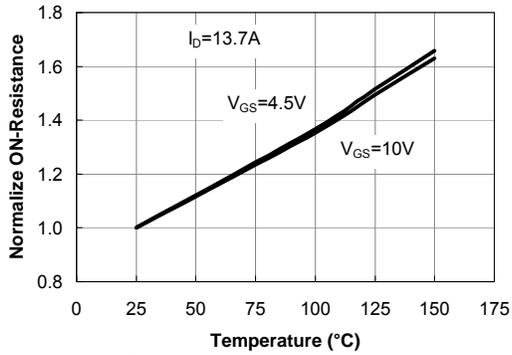


Figure 4: On-Resistance vs. Junction Temperature

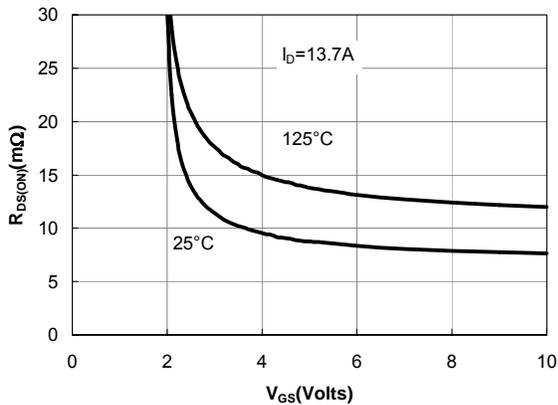


Figure 5: On-Resistance vs. Gate-Source Voltage

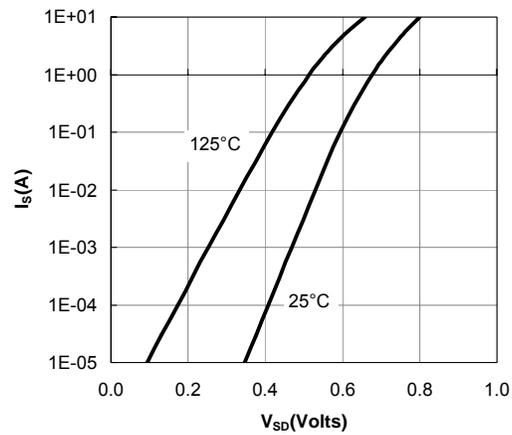


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

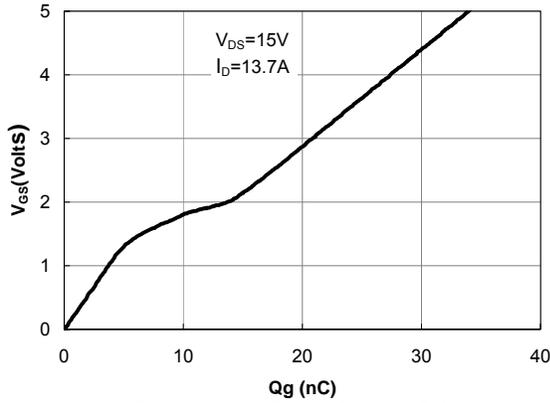


Figure 7: Gate-Charge Characteristics

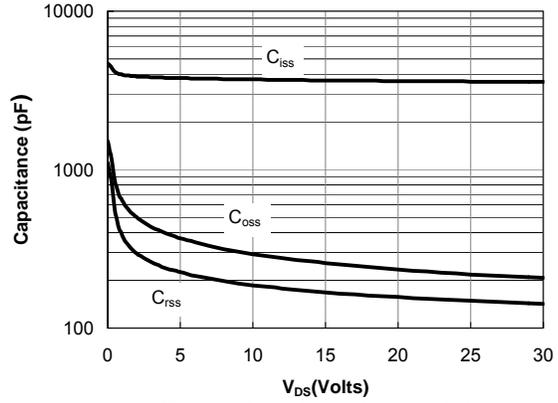


Figure 8: Capacitance Characteristics

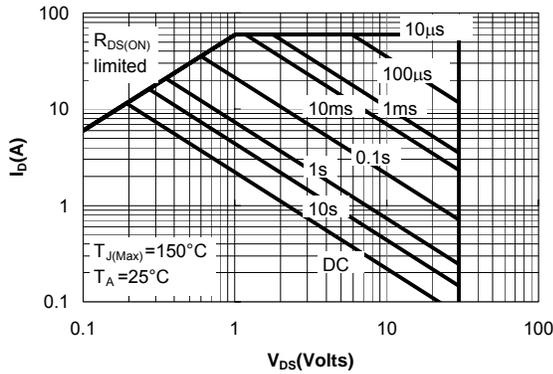


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

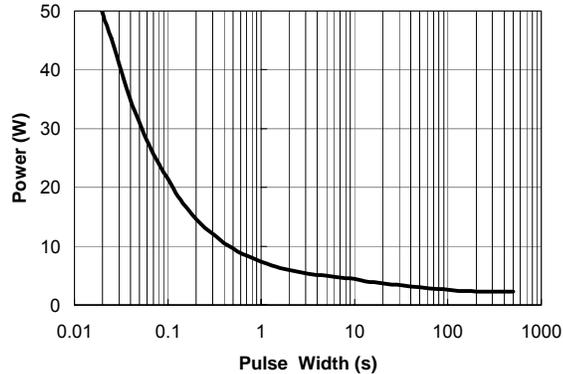


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

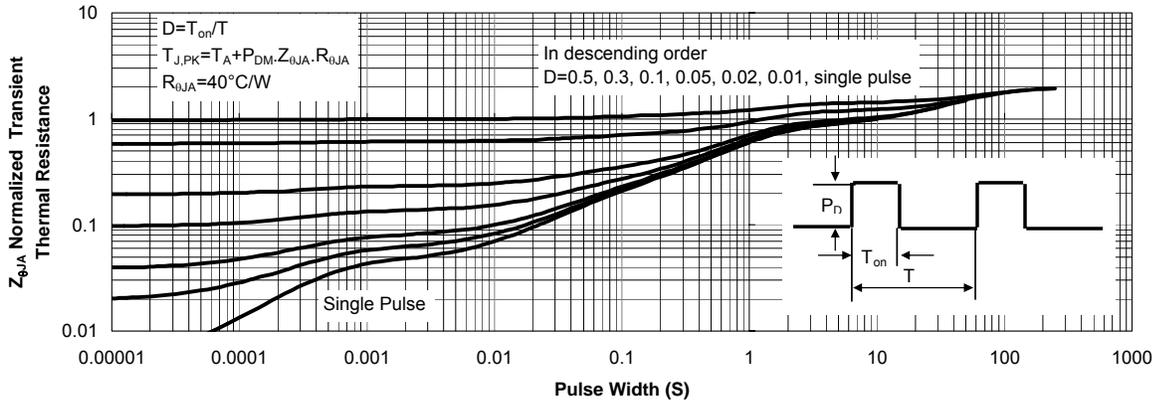


Figure 11: Normalized Maximum Transient Thermal Impedance